



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	BV _{DSS}	RDS(ON) Max	ID MAX TA = +25°C
Q1	20V	$35m\Omega$ @ V _{GS} = 4.5V	4.6A
N-Channel	43mΩ @ V _{GS} = 2.5V	4.1A	
Q2	201/	$75m\Omega$ @ V _{GS} = -4.5V	-3.1A
P-Channel	-20V	110mΩ @ V _{GS} = -2.5V	-2.6A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, which makes it ideal for high-efficiency power management applications.

- Load switches
- Power management functions
- · Portable power adaptors

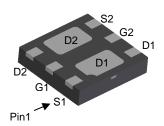
Features

- PCB Footprint of 4mm²
- Low On-Resistance
- Low Input Capacitance
- Low Profile, 0.6mm Maximum Height
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- An automotive-compliant part is available under separate datasheet (<u>DMC2053UFDBQ</u>)

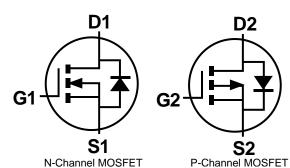
Mechanical Data

- Package: U-DFN2020-6
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (4)
- Terminals Connections: See Diagram Below
- Weight: 0.0065 grams (Approximate)

U-DFN2020-6 (Type B)



Bottom View



Internal Schematic

Ordering Information (Note 4)

Part Number	Package	Packing			
Fait Number	rackaye	Qty.	Carrier		
DMC2053UFDB-7	U-DFN2020-6 (Type B)	3,000	Tape & Reel		
DMC2053UFDB-13	U-DFN2020-6 (Type B)	10,000	Tape & Reel		

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



H4 = Product Type Marking Code YWX = Date Code Marking

Y = Year (ex: 3 = 2023)

W = Week (ex: a = Week 27; z Represents Week 52 and 53)

X = Internal Code (ex: U = Monday)

Date Code Key

Year	2019	-	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	9	-	3	4	5	6	7	8	9	0	1	2

Week	1-26	27-52	53
Code	A-Z	a-z	z

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	T	U	V	W	X	Y	Z
· · · · · · · · · · · · · · · · · · ·							



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Q1 N-CHANNEL	Q2 P-CHANNEL	Unit		
Drain-Source Voltage	Drain-Source Voltage				-20	V
Gate-Source Voltage	V_{GSS}	±12	±12	V		
Continuous Drain Current (Note 6) N-Channel: VGS = 4.5V P-Channel: VGS = -4.5V	Steady State	T _A = +25°C T _A = +70°C	lo	4.6 3.7	-3.1 -2.5	А
Maximum Continuous Body Diode Forward Cur	Is	1.1	-1.05	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle =	I _{DM}	24	-15	А		

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	PD	0.82	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Rөja	153	°C/W
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	P _D	1.14	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Rөja	110	°C/W
Operating and Storage Temperature Range	$T_{J,}T_{STG}$	-55 to +150	°C	

Electrical Characteristics Q1 N-CHANNEL (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 7)	-			•				
Drain-Source Breakdown Voltage	BV _{DSS}	20	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$		
Zero Gate Voltage Drain Current T _J = +25°C	IDSS	_	_	1.0	μΑ	V _{DS} = 20V, V _{GS} = 0V		
Gate-Source Leakage	lgss	_	_	±100	nA	$V_{GS} = \pm 12V$, $V_{DS} = 0V$		
ON CHARACTERISTICS (Note 7)								
Gate Threshold Voltage	Vgs(th)	0.4	_	1.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$		
			24	35		$V_{GS} = 4.5V, I_D = 5A$		
Static Drain-Source On-Resistance	RDS(ON)	_	30	43	mΩ	$V_{GS} = 2.5V, I_{D} = 4A$		
			44	56		V _G S = 1.8V, I _D = 2A		
Diode Forward Voltage	V_{SD}	_	0.7	1.2	V	$V_{GS} = 0V$, $I_{S} = 1A$		
DYNAMIC CHARACTERISTICS (Note 8)								
Input Capacitance	C _{iss}	_	369	_				
Output Capacitance	Coss	_	54	_	pF	$V_{DS} = 10V, V_{GS} = 0V,$ f = 1.0MHz		
Reverse Transfer Capacitance	Crss	_	32	_				
Gate Resistance	Rg	_	4.1	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$		
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	3.6	_				
Total Gate Charge (V _{GS} = 10V)	Qg	_	7.7	_	nC	\/ 40\/ I- CA		
Gate-Source Charge	Qgs	_	0.4	_	nc	$V_{DS} = 10V$, $I_D = 6A$		
Gate-Drain Charge	Q_{gd}	_	1.0	_				
Turn-On Delay Time	t _D (ON)	_	2.6	_				
Turn-On Rise Time	t _R	_	3.0	_	20	$V_{DS} = 10V, V_{GS} = 4.5V,$		
Turn-Off Delay Time	t _{D(OFF)}	_	12.5	_	ns	$R_g = 6\Omega$, $R_L = 10\Omega$, $I_D = 6A$		
Turn-Off Fall Time	t _F	_	3.6	_				
Reverse Recovery Time	trr	_	6.0	_	ns	I _F = 1A, di/dt = 100A/μs		
Reverse Recovery Charge	Q _{RR}		0.9		nC	IF = 1A, di/dt = 100A/µs		

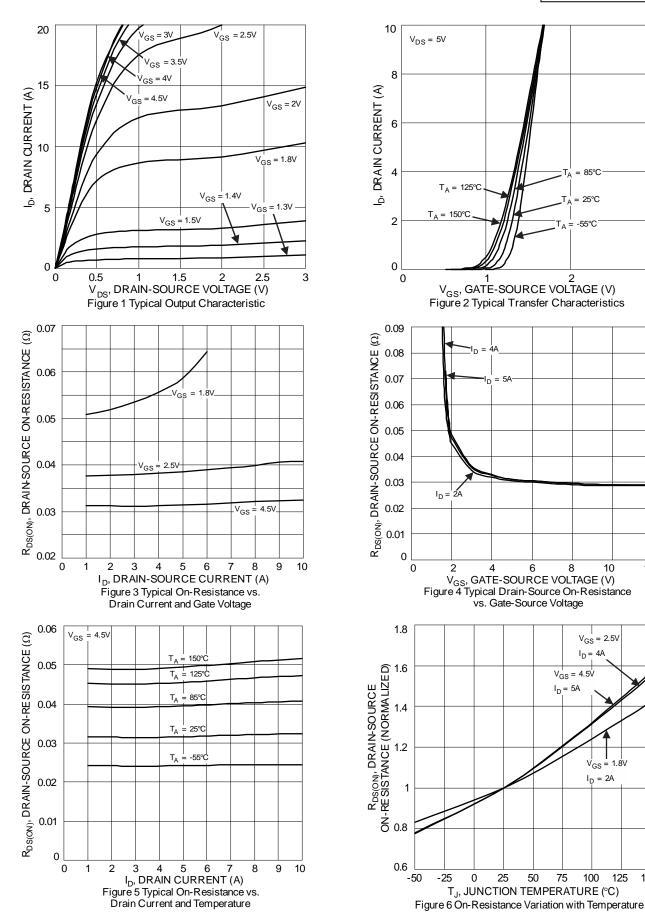
5. Device mounted on FR-4 substrate PCB, 2oz copper, with minimum recommended pad layout.6. Device mounted on FR-4 substrate PCB, 2oz copper, with 1inch square copper plate.7. Short duration pulse test used to minimize self-heating effect.

^{8.} Guaranteed by design. Not subject to product testing.

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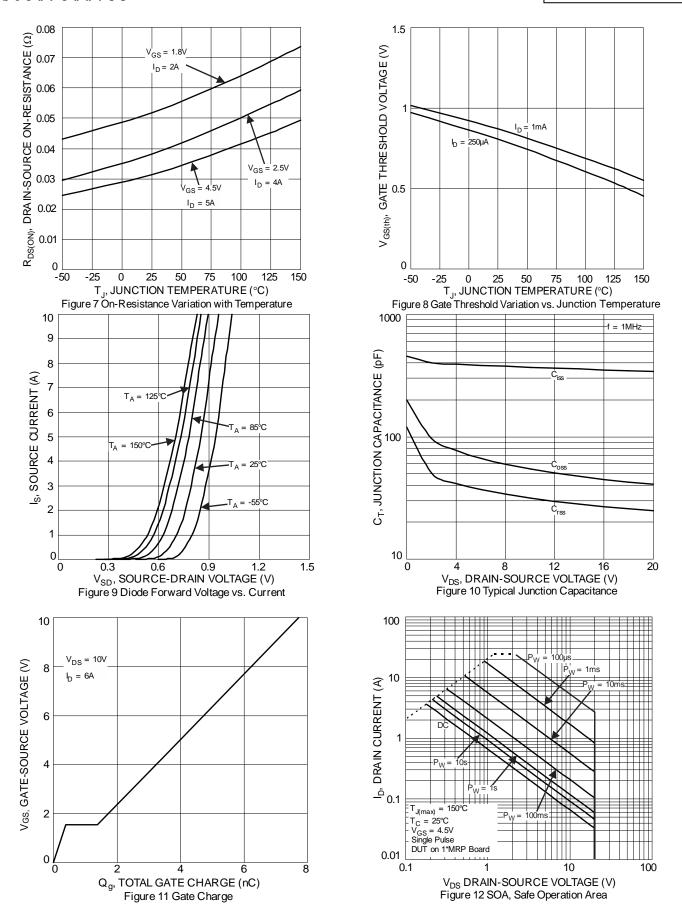




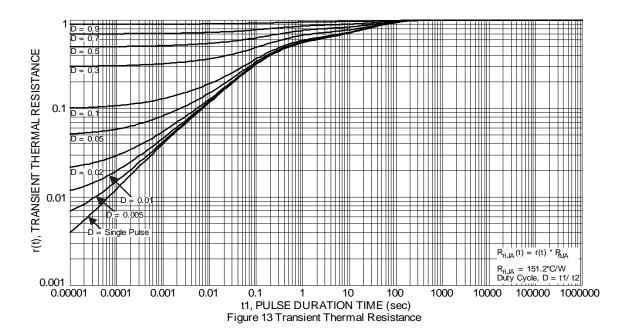
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150











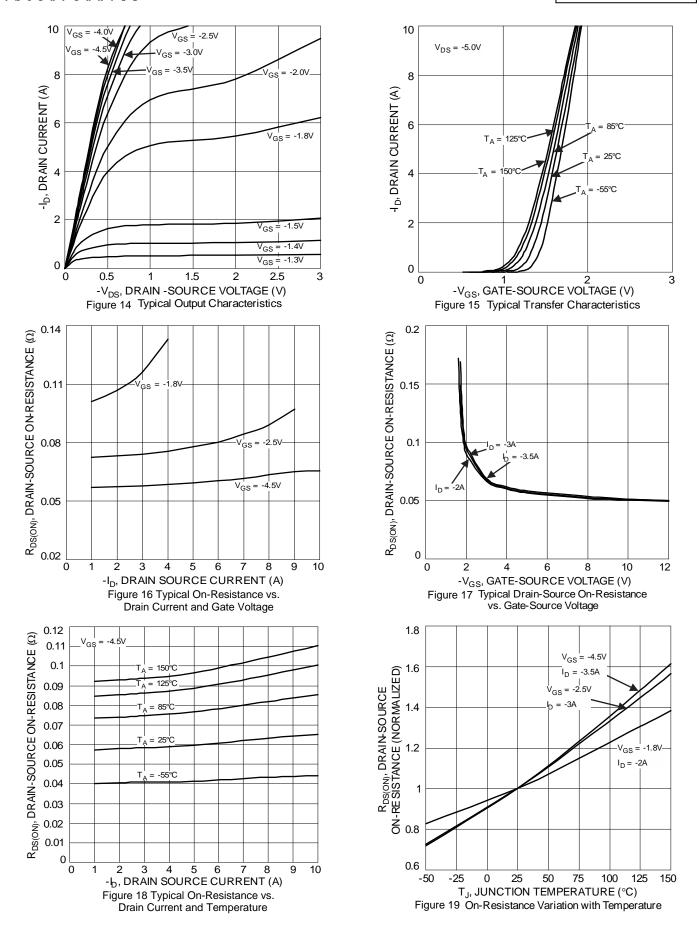
Electrical Characteristics Q2 P-CHANNEL (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition			
OFF CHARACTERISTICS (Note 7)		•				•			
Drain-Source Breakdown Voltage	BVDSS	-20	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$			
Zero Gate Voltage Drain Current T _J = +25°C	IDSS		_	-1.0	μΑ	V _{DS} = -20V, V _{GS} = 0V			
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 12V$, $V_{DS} = 0V$			
ON CHARACTERISTICS (Note 7)									
Gate Threshold Voltage	V _{GS(TH)}	-0.45	_	-1.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$			
		_	57	75		$V_{GS} = -4.5V$, $I_D = -3.5A$			
Static Drain-Source On-Resistance	R _{DS(ON)}	_	73	110	mΩ	V _{GS} = -2.5V, I _D = -3.0A			
		_	105	168		V _G S = -1.8V, I _D = -2.0A			
Diode Forward Voltage	VsD	_	-0.7	-1.2	V	V _G S = 0V, I _S = -1.0A			
DYNAMIC CHARACTERISTICS (Note 8)		•				•			
Input Capacitance	Ciss	_	440	_	pF				
Output Capacitance	Coss	_	60	_	pF	$V_{DS} = -10V, V_{GS} = 0V,$ f = 1.0MHz			
Reverse Transfer Capacitance	Crss	_	48	_	pF	-1 = 1.0MHZ			
Gate Resistance	Rg	_	8.5	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$			
Total Gate Charge (V _{GS} = -4.5V)	_	_	5.9	_	nC				
Total Gate Charge (V _{GS} = -8V)	Q_g	_	12.7	_	nC],, a,, a,,			
Gate-Source Charge	Qgs	_	0.6	_	nC	$V_{DS} = -4V$, $I_{D} = -3.5A$			
Gate-Drain Charge	Q _{gd}	_	2.1	_	nC				
Turn-On Delay Time	t _{D(ON)}	_	3.2	_	ns				
Turn-On Rise Time	t _R	_	7.8	_	ns	V _{DS} = -4V, V _{GS} = -4.5V,			
Turn-Off Delay Time	Off Delay Time t _{D(OFF)}		31	_	ns	$R_L = 4\Omega$, $R_g = 6\Omega$			
Turn-Off Fall Time	t _F	_	18	_	ns				
Body Diode Reverse Recovery Time	trr	_	10.5	_	ns	Is = -2.0A, dI/dt = 100A/µs			
Body Diode Reverse Recovery Charge	Qrr	_	3.0	_	nC	Is = -2.0A, dI/dt = 100A/µs			

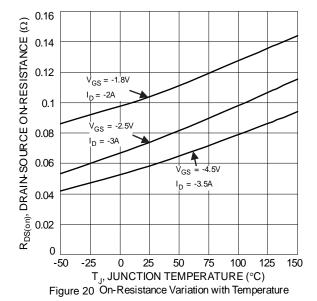
Notes:

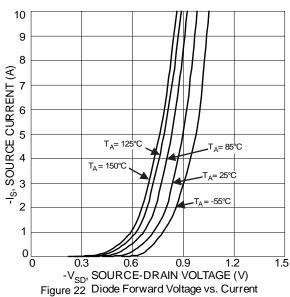
^{7.} Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.

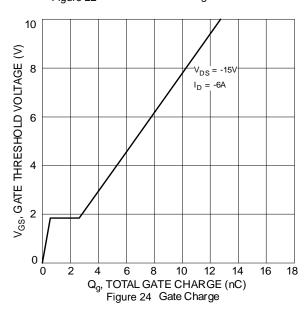


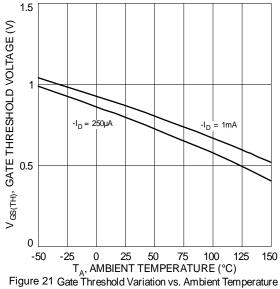


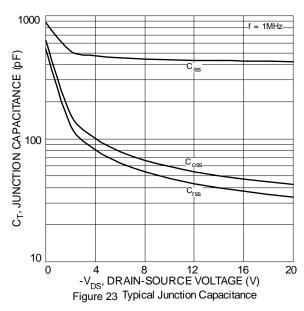


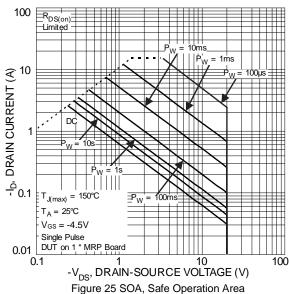








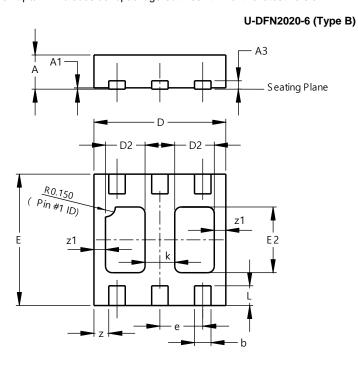






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

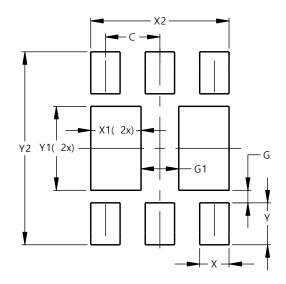


U-DFN2020-6 Type B						
Dim	Min	Max	Тур			
Α	0.545	0.605	0.575			
A1	0.00	0.05	0.02			
А3	-	-	0.13			
b	0.20	0.30	0.25			
D	1.95	2.075	2.00			
D2	0.50	0.70	0.60			
е	-	-	0.65			
Е	1.95	2.075	2.00			
E2	0.90	1.10	1.00			
k	-	-	0.45			
L	0.25	0.35	0.30			
z	-	-	0.225			
z1	-	-	0.175			
All I	Dimens	ions in	mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type B)



Dimensions	Value (in mm)
С	0.650
G	0.150
G1	0.450
Х	0.350
X1	0.600
X2	1.650
Υ	0.500
Y1	1.000
Y2	2.300



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